

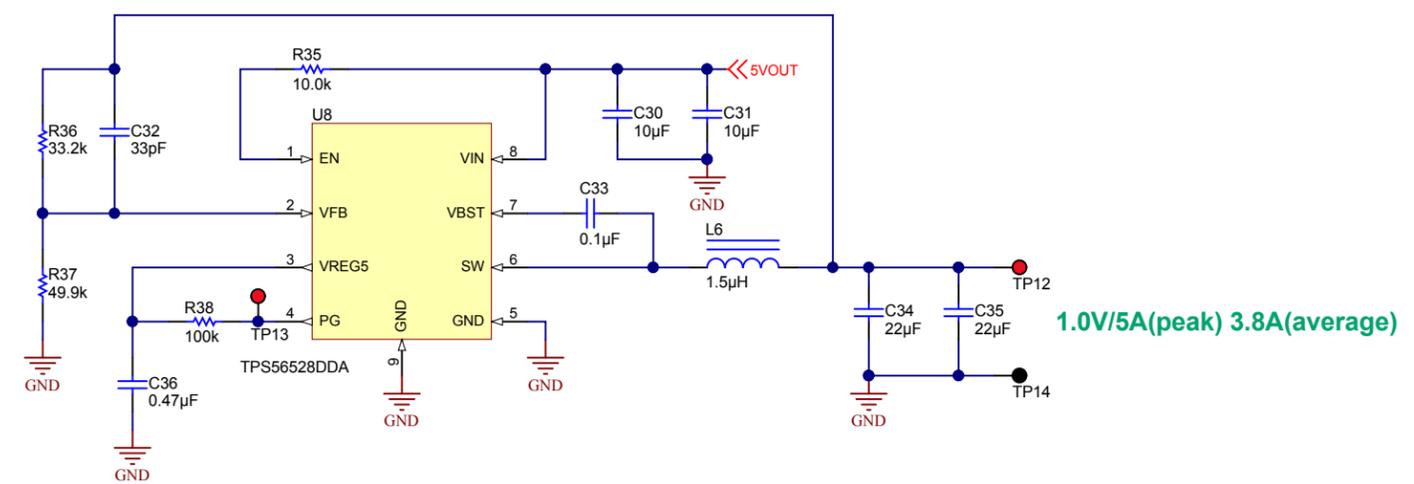
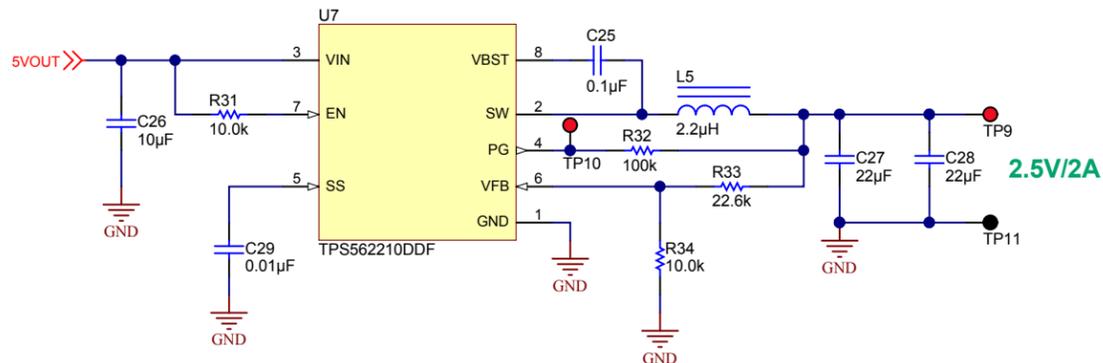
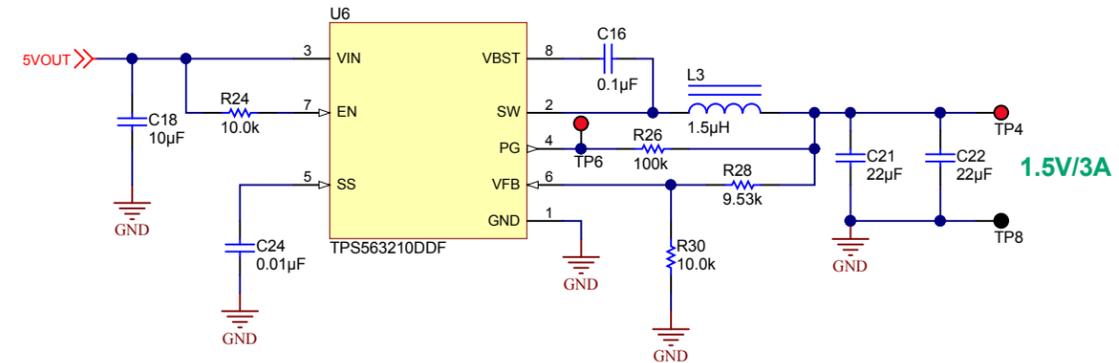
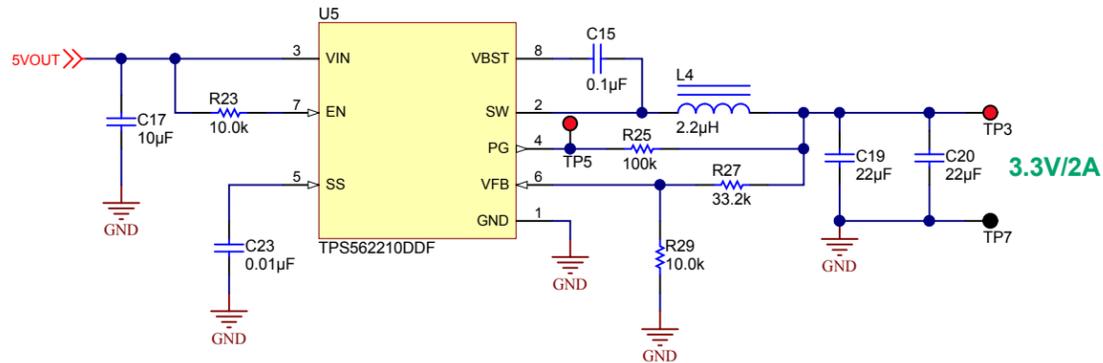
DANGER HIGH VOLTAGE

PCB Number: PMP11180
PCB Rev: A

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Orderable: N/A	Designed for:	Mod. Date: 9/25/2015
TID #:	Project Title: 25W AC/DC STB Reference Design	
Number: PMP11180	Rev: A	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 2
Drawn By:	File: PMP11180_REVA_SHEET1.SchDoc	Size: B
Engineer: B King	Contact: http://www.ti.com/support	





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